

Filterless High Efficiency Mono 1.4 W Class-D Audio Amplifier

SSM2301

FEATURES

Filterless Class-D amplifier with Σ-Δ modulation No sync necessary when using multiple Class-D amplifiers from Analog Devices, Inc.

1.4 W into 8 Ω at 5.0 V supply with less than 1% THD + N 85% efficiency at 5.0 V, 1.4 W into 8 Ω speaker Greater than 98 dB SNR (signal-to-noise ratio) Single-supply operation from 2.5 V to 5.0 V 20 nA ultralow shutdown current Short-circuit and thermal protection Available in 8-lead, 3 mm × 3 mm LFCSP and MSOP packages Pop-and-click suppression **Built-in resistors reduce board component count** Fixed and user-adjustable gain configurations

APPLICATIONS

Mobile phones MP3 players Portable gaming **Portable electronics Educational toys**

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GENERAL DESCRIPTION

The SSM2301 is a fully integrated, high efficiency, Class-D audio amplifier designed to maximize performance for mobile phone applications. The application circuit requires a minimum of external components and operates from a single 2.5 V to 5.0 V supply. It is capable of delivering 1.4 W of continuous output power with less than 1% THD + N driving an 8 Ω load from a 5.0 V supply.

The SSM2301 features a high efficiency, low noise modulation scheme that does not require external LC output filters. The modulation provides high efficiency even at low output power.

The SSM2301 operates with 85% efficiency at 1.4 W into 8 Ω from a 5.0 V supply and has a signal-to-noise ratio (SNR) that is greater than 98 dB. Spread-spectrum modulation is used to provide lower EMI-radiated emissions compared with other Class-D architectures.

The SSM2301 has a micropower shutdown mode with a maximum shutdown current of 30 nA. Shutdown is enabled by applying a logic low to the SD pin.

The device also includes pop-and-click suppression circuitry. This minimizes voltage glitches at the output during turn-on and turn-off, thus reducing audible noise on activation and deactivation.

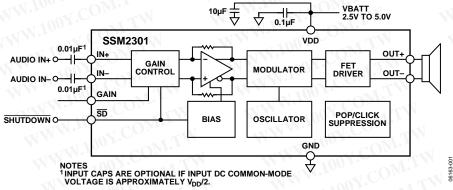
The fully differential input of the SSM2301 provides excellent rejection of common-mode noise on the input. Input coupling capacitors can be omitted if the dc input common-mode voltage is approximately V_{DD}/2.

The SSM2301 also has excellent rejection of power supply noise, including noise caused by GSM transmission bursts and RF rectification. PSRR is typically 63 dB at 217 Hz.

The gain can be set to 6 dB or 12 dB by utilizing the gain control select pin connected respectively to ground or to VDD. Gain can also be adjusted externally by inserting a resistor in series with each input pin.

The SSM2301 is specified over the commercial temperature range (-40°C to +85°C). It has built-in thermal shutdown and output short-circuit protection. It is available in both an 8-lead, 3 mm × 3 mm lead-frame chip scale package (LFCSP) and an 8-lead MSOP package.

FUNCTIONAL BLOCK DIAGRAM



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REVISION HISTORY

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Changes to Ordering Guide14

WWW.100Y.COM.TW 1/07—Revision 0: Initial Version

SPECIFICATIONS

WWW.100Y.C $V_{DD} = 5.0 \text{ V}, T_A = 25^{\circ}\text{C}, R_L = 8 \ \Omega + 33 \ \mu\text{H}, unless otherwise noted}.$

Table 1.	O.Y.	TW WY 100Y. COM.TW				1
Parameter	Symbol	Conditions	Min	Тур	Max	Un
DEVICE CHARACTERISTICS	1007.Co	THE WILLIAM TOOK	N			
Output Power	Po	$V_{DD} = 5.0 \text{ V}, R_L = 8 \Omega, THD = 1\%$ f = 1 kHz, 20 kHz BW	IN	1.22		W
	N.100Y.	$V_{DD} = 5.0 \text{ V}, R_L = 8 \Omega, THD = 10\%$ f = 1 kHz, 20 kHz BW	TW	1.52		W
	W.100X	$V_{DD} = 3.6 \text{ V}, R_L = 8 \Omega, THD = 1\%$ f = 1 kHz, 20 kHz BW	V.7.	590		m۷
	MM.100	$V_{DD} = 3.6 \text{ V}, R_L = 8 \Omega, THD = 10\%$ f = 1 kHz, 20 kHz BW		775		m۷
	MW.10	$V_{DD} = 2.5 \text{ V}, R_L = 8 \Omega, THD = 1\%$ f = 1 kHz, 20 kHz BW	COM	275		m۷
	WWW.	$V_{DD} = 2.5 \text{ V}, R_L = 8 \Omega, THD = 10\%$ f = 1 kHz, 20 kHz BW	CO	345		m۷
Efficiency	η	$P_{OUT} = 1.4 \text{ W}, 8 \Omega, V_{DD} = 5.0 \text{ V}$	Y.CC	85		%
Total Harmonic Distortion + Noise	THD + N	$P_0 = 1 \text{ W into } 8 \Omega, f = 1 \text{ kHz}, V_{DD} = 5.0 \text{ V}$	V.C	0.1		%
	111.	$P_0 = 0.5 \text{ W into } 8 \Omega, f = 1 \text{ kHz}, V_{DD} = 3.6 \text{ V}$	0 1	0.04		%
Input Common-Mode Voltage Range	V _{CM}	WY WY	1.0		$V_{DD} - 1.0$	V
Common-Mode Rejection Ratio	CMRR _{GSM}	$V_{CM} = 2.5 \text{ V} \pm 100 \text{ mV}$ at 217 Hz	-05	55		dB
Average Switching Frequency	f _{sw}	1001. CON.III	70a	1.8		ME
Differential Output Offset Voltage	Voos	G = 6 dB; G = 12 dB	1 100	2.0		m۷
POWER SUPPLY	(MMM. TON COMMENT WIN	4.	ov.C	WT	
Supply Voltage Range	V_{DD}	Guaranteed from PSRR test	2.5		5.0	V
Power Supply Rejection Ratio	PSRR	$V_{DD} = 2.5 \text{ V}$ to 5.0 V, dc input floating/ground	70	85		dB
MAMAIN TOOX COM	PSRR _{GSM}	V_{RIPPLE} = 100 mV at 217 Hz, inputs are ac grounded, C_{IN} = 0.01 μ F, input referred		63		dB
Supply Current	I _{SY}	$V_{IN} = 0 \text{ V, no load, } V_{DD} = 5.0 \text{ V}$	NA .	4.2		m/
TANN TO CON	-XX	$V_{IN} = 0 \text{ V}$, no load, $V_{DD} = 3.6 \text{ V}$	NW	3.5		m/
	$T_{I,I,I}$	$V_{IN} = 0 \text{ V, no load, } V_{DD} = 2.5 \text{ V}$	- 7XX	2.9		m/
Shutdown Current	I _{SD}	$\overline{SD} = GND$	1/1/1/	20		nA
GAIN CONTROL		MAN, W. CO.	W	N	TOTAL CO	- 1
Closed-Loop Gain	A _V 0	GAIN pin = 0 V		6		dB
MM. 100X.	A _V 1	$GAIN pin = V_{DD}$		12		dB
Differential Input Impedance	Z _{IN}	$\overline{SD} = V_{DD}, \overline{SD} = GND$	1	150		kΩ
	COM	MANNING COM.		210		kΩ
SHUTDOWN CONTROL	. Mor	11.100 COM'3		- 1	111.100	
Input Voltage High	V _{IH}	I _{SY} ≥ 1 mA		1.2		٧
Input Voltage Low	V _{IL}	I _{SY} ≤ 300 nA		0.5		V
Turn-On Time	twu	SD rising edge from GND to V _{DD}	• K.T	30		ms
Turn-Off Time	t _{SD}	SD falling edge from V _{DD} to GND		5		μs
Output Impedance	Zout	SD = GND	W	>100		kΩ
NOISE PERFORMANCE	700.5	DAY TOWN	-181		WW.	V
Output Voltage Noise	e _n	$V_{DD} = 2.5 \text{ V}$ to 5.0 V, f = 20 Hz to 20 kHz, inputs are ac grounded, sine wave, $A_V = 6 \text{ dB}$, A weighting	IN	35		μV
Signal-to-Noise Ratio	SNR	$P_{OUT} = 1.4 \text{ W}, R_L = 8 \Omega$	1.	98		dB

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ABSOLUTE MAXIMUM RATINGS

Absolute maximum ratings apply at 25°C, unless otherwise noted.

Table 2.

Parameter	Rating
Supply Voltage	6V
Input Voltage	V _{DD}
Common-Mode Input Voltage	V _{DD}
Storage Temperature Range	−65°C to +150°C
Operating Temperature Range	-40°C to +85°C
Junction Temperature Range	−65°C to +165°C
Lead Temperature (Soldering, 60 sec)	300°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

 θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 3. Thermal Resistance

Package Type	θја	Ө лс	Unit
8-lead, 3 mm × 3 mm LFCSP	62	20.8	°C/W
8-lead MSOP	210	45	°C/W

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



Figure 2. LFCSP Pin Configuration

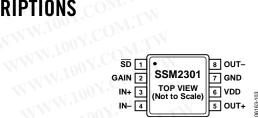


Figure 3. MSOP Pin Configuration

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GND Ground.	Pin No.	Mnemonic	Description
IN+ Noninverting Input. IN- Inverting Input. OUT+ Noninverting Output. VDD Power Supply. GND Ground.	1 CO	SD	Shutdown Input. Active low digital input.
IN- Inverting Input. OUT+ Noninverting Output. VDD Power Supply. GND Ground.	2 00 3	GAIN	Gain Selection. Digital input.
OUT+ Noninverting Output. VDD Power Supply. GND Ground.	3	IN+	Noninverting Input.
VDD Power Supply. GND Ground.	4	O IN-	Inverting Input.
GND Ground.	5 100	OUT+	Noninverting Output.
	6	VDD	Power Supply.
OUT Inverting Output	7	GND	Ground.
1 inverting Output.	8	OUT-	Inverting Output.

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TYPICAL PERFORMANCE CHARACTERISTICS

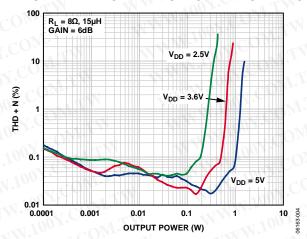


Figure 4. THD + N vs. Output Power into 8 Ω , $A_V = 6 dB$

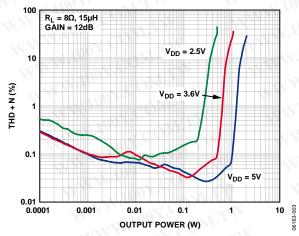


Figure 5. THD + N vs. Output Power into 8 Ω , $A_V = 12 dB$

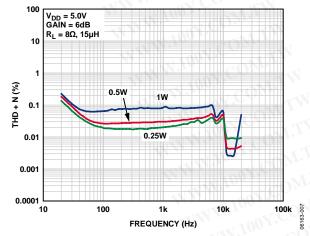


Figure 6. THD + N vs. Frequency, $V_{DD} = 5.0 \text{ V}$, $A_V = 6 \text{ dB}$, $R_L = 8 \Omega$

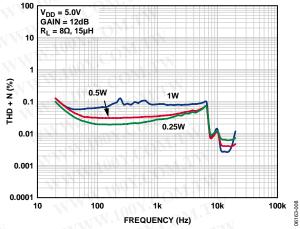


Figure 7. THD + N vs. Frequency, V_{DD} = 5.0 V, A_V = 12 dB, R_L = 8 Ω

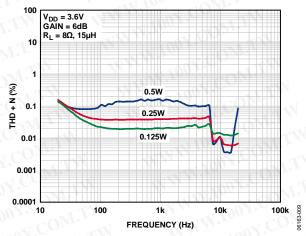


Figure 8. THD + N vs. Frequency, V_{DD} = 3.6 V, A_V = 6 dB, R_L = 8 Ω

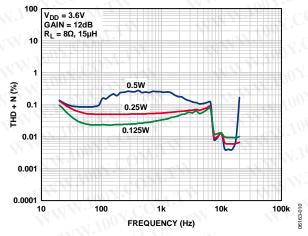


Figure 9. THD + N vs. Frequency, V_{DD} = 3.6 V, A_V = 12 dB, R_L = 8 Ω

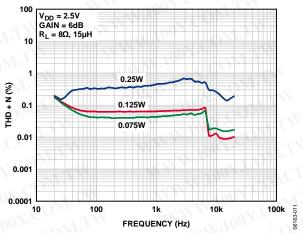


Figure 10. THD + N vs. Frequency, V_{DD} = 2.5 V, A_V = 6 dB, R_L = 8 Ω

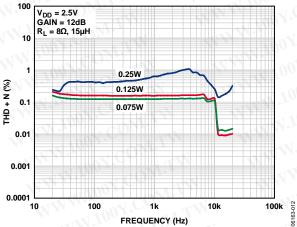


Figure 11. THD + N vs. Frequency, V_{DD} = 2.5 V, A_V = 12 dB, R_L = 8 Ω

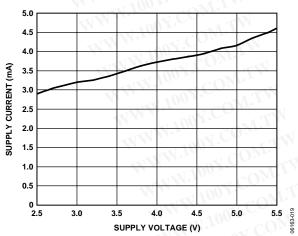


Figure 12. Supply Current vs. Supply Voltage, No Load

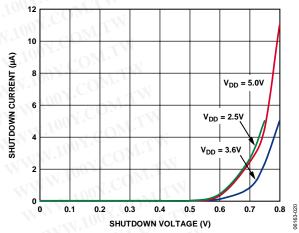


Figure 13. Shutdown Current vs. Shutdown Voltage

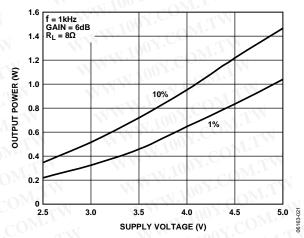


Figure 14. Maximum Output Power vs. Supply Voltage, $A_V = 6 \text{ dB}$, $R_L = 8 \Omega$,

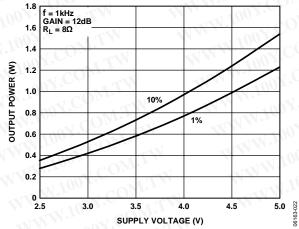


Figure 15. Maximum Output Power vs. Supply Voltage, $A_V = 12$ dB, $R_L = 8 \Omega$

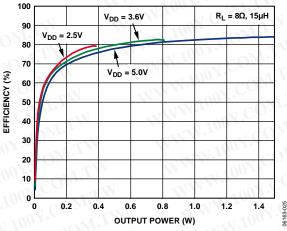
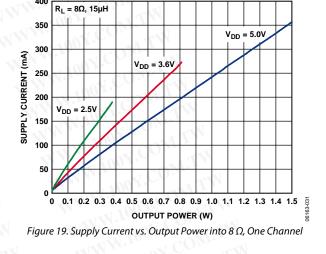


Figure 16. Efficiency vs. Output Power into 8 Ω



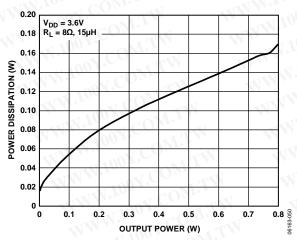


Figure 17. Power Dissipation vs. Output Power into 8 Ω at V_{DD} = 3.6 V

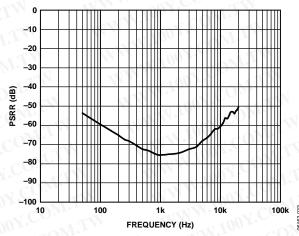


Figure 20. Power Supply Rejection Ratio vs. Frequency

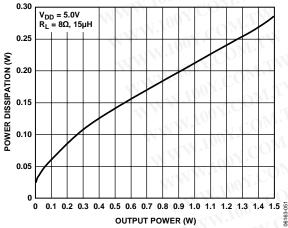


Figure 18. Power Dissipation vs. Output Power into 8 Ω at V_{DD} = 5.0 V

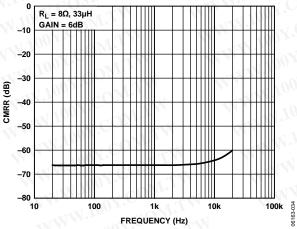
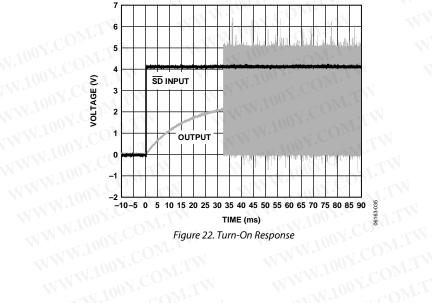
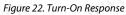
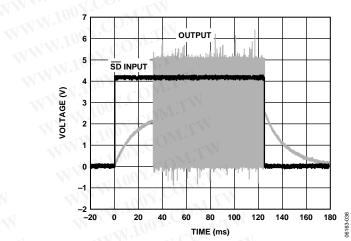


Figure 21. Common-Mode Rejection Ratio vs. Frequency



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Figure 23. Turn-Off Response WWW.100Y.CO WWW.100Y.COM.TW

TYPICAL APPLICATION CIRCUITS

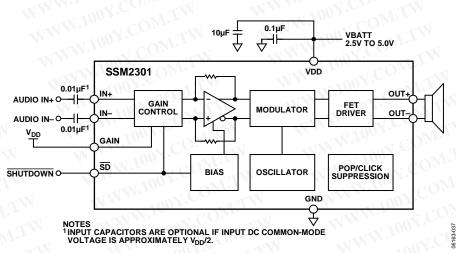


Figure 24. Differential Input Configuration, Gain = 12 dB

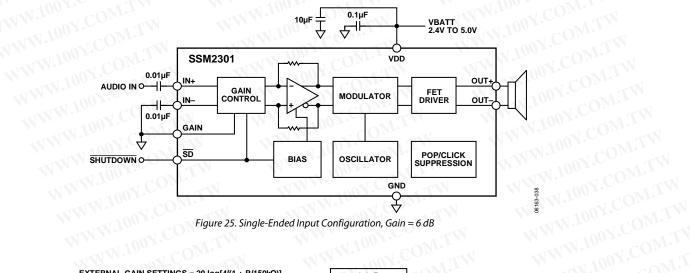


Figure 25. Single-Ended Input Configuration, Gain = 6 dB

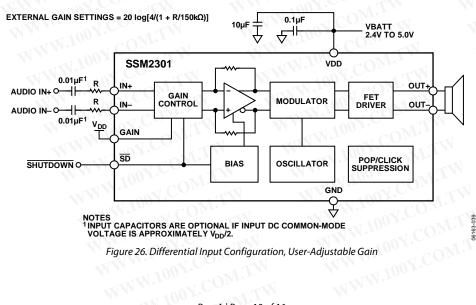


Figure 26. Differential Input Configuration, User-Adjustable Gain

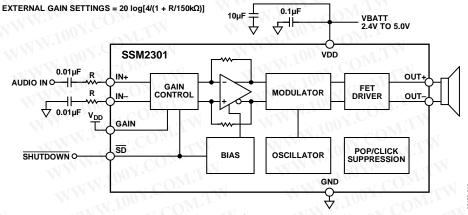


Figure 27. Single-Ended Input Configuration, User-Adjustable Gain

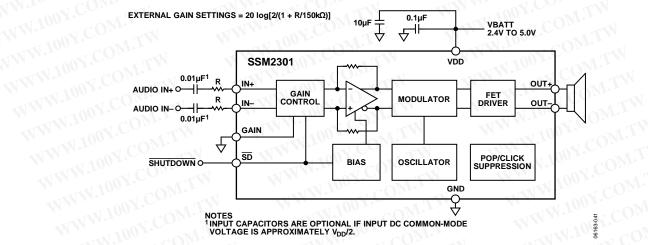


Figure 28. Differential Input Configuration, User-Adjustable Gain

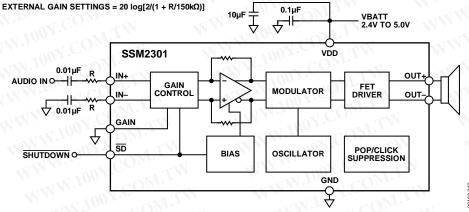


Figure 29. Single-Ended Input Configuration, User-Adjustable Gain

APPLICATIONS INFORMATION

OVERVIEW

The SSM2301 mono Class-D audio amplifier features a filterless modulation scheme that greatly reduces external component count, conserving board space and, thus, reducing system cost. The SSM2301 does not require an output filter but, instead, relies on the inherent inductance of the speaker coil and the natural filtering of the speaker and human ear to fully recover the audio component of the square-wave output. While most Class-D amplifiers use some variation of pulse-width modulation (PWM), the SSM2301 uses a Σ - Δ modulation to determine the switching pattern of the output devices. This provides a number of important benefits. Σ - Δ modulators do not produce a sharp peak with many harmonics in the AM frequency band, as pulse-width modulators often do. Σ - Δ modulation reduces the amplitude of spectral components at high frequencies, thereby reducing EMI emission that might otherwise be radiated by speakers and long cable traces. The SSM2301 also offers protection circuitry for output shortcircuit and high temperature conditions. When the fault-inducing condition is removed, the SSM2301 automatically recovers without the need for a hard reset.

GAIN SELECTION

Pulling the GAIN pin of the SSM2301 high sets the gain of the speaker amplifier to 12 dB; pulling it low sets the gain of the speaker amplifier to 6 dB.

It is possible to adjust the SSM2301 gain by using external resistors at the input. To set a gain lower than 12 dB, see Figure 26 for differential input configuration and Figure 27 for single-ended configuration. For external gain configuration from a fixed 12 dB gain, use the following formula:

External Gain Settings = $20 \log[4/(1 + R/150 \text{ k}\Omega)]$

To set a gain lower than 6 dB, see Figure 28 for differential input configuration and Figure 29 for single-ended configuration. For external gain configuration from a fixed 6 dB gain, use the following formula:

External Gain Settings = $20 \log[2/(1 + R/150 k\Omega)]$

POP-AND-CLICK SUPPRESSION

Voltage transients at the output of audio amplifiers may occur when shutdown is activated or deactivated. Voltage transients as low as 10 mV can be heard as an audio pop in the speaker. Clicks and pops can also be classified as undesirable audible transients generated by the amplifier system and, therefore, as not coming from the system input signal. Such transients may be generated when the amplifier system changes its operating mode. For example, the following can be sources of audible transients: system power-up/power-down, mute/unmute, input source change, and sample rate change. The SSM2301 has a pop-and-click suppression architecture that reduces these output transients, resulting in noiseless activation and deactivation.

LAYOUT

As output power continues to increase, care must be taken to lay out PCB traces and wires properly between the amplifier, load, and power supply. A good practice is to use short, wide PCB tracks to decrease voltage drops and minimize inductance. Make track widths at least 200 mil for every inch of track length for lowest DCR, and use 1 oz or 2 oz of copper PCB traces to further reduce IR drops and inductance.

Poor layout increases voltage drops, consequently affecting efficiency. Use large traces for the power supply inputs and amplifier outputs to minimize losses due to parasitic trace resistance. Proper grounding guidelines help improve audio performance, minimize crosstalk between channels, and prevent switching noise from coupling into the audio signal. To maintain high output swing and high peak output power, PCB traces that connect the output pins to the load and supply pins should be as wide as possible to maintain the minimum trace resistances.

It is also recommended that a large-area ground plane be used for minimum impedances. Good PCB layouts also isolate critical analog paths from sources of high interference. High frequency circuits (analog and digital) should be separated from low frequency circuits. Properly designed multilayer printed circuit boards can reduce EMI emission and increase immunity to the RF field by a factor of 10 or more compared with double-sided boards. A multilayer board allows a complete layer to be used for the ground plane, whereas the ground plane side of a double-side board is often disrupted with signal crossover. If the system has separate analog and digital ground and power planes, the analog ground plane should be underneath the analog power plane, and, similarly, the digital ground plane should be underneath the digital power plane. There should be no overlap between analog and digital ground planes or analog and digital power planes.

INPUT CAPACITOR SELECTION

The SSM2301 does not require input coupling capacitors if the input signal is biased from 1.0 V to $V_{\rm DD}$ – 1.0 V. Input capacitors are required if the input signal is not biased within this recommended input dc common-mode voltage range, if high-pass filtering is needed (see Figure 24) or if using a single-ended source (see Figure 25). If high-pass filtering is needed at the input, the input capacitor, along with the input resistor of the SSM2301, forms a high-pass filter whose corner frequency is determined by the following equation:

$$f_C = 1/(2\pi \times R_{IN} \times C_{IN})$$

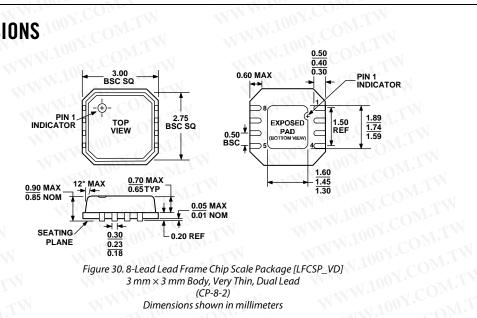
The input capacitor can have very important effects on the circuit performance. Not using input capacitors degrades the output offset of the amplifier as well as the PSRR performance.

PROPER POWER SUPPLY DECOUPLING

To ensure high efficiency, low total harmonic distortion (THD), and high PSRR, proper power supply decoupling is necessary. Noise transients on the power supply lines are short-duration voltage spikes. Although the actual switching frequency can range from 10 kHz to 100 kHz, these spikes can contain frequency components that extend into the hundreds of megahertz.

The power supply input needs to be decoupled with a good quality low ESL and low ESR capacitor, usually around 4.7 μE . This capacitor bypasses low frequency noises to the ground plane. For high frequency transients noises, use a 0.1 μE capacitor placed as close as possible to the VDD pin of the device. Placing the decoupling capacitor as close as possible to the SSM2301 helps maintain efficient performance.

OUTLINE DIMENSIONS



WWW.100Y.COM.TW Dimensions shown in millimeters

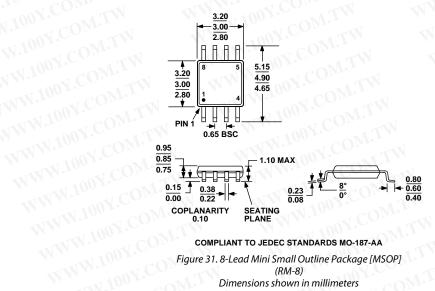


Figure 31. 8-Lead Mini Small Outline Package [MSOP]
(RM-8)
Dimensions chart

ORDERING GUIDE

odel	Temperature Range	Package Description	Package Option	Branding
SM2301CPZ-R2 ¹	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-2	A1C
SM2301CPZ-REEL ¹	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-2	A1C
SM2301CPZ-REEL7 ¹	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-2	A1C
SM2301RMZ-R2 ¹	−40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	A1C
SM2301RMZ-REEL ¹	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	A1C
SM2301RMZ-REEL7 ¹	−40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	A1C
M2301-EVALZ ¹	TXIV.	Evaluation Board with LFCSP Model	ONI.	WIX

¹ Z = RoHS Compliant Part.

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WWW.100X.C

WWW.1007.C

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WWW.100Y.CO

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